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February 18, 2005

Via Facsimile 703.872.9306

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Re: Serial No.: 10/080,785
High Performance Powdered Metal Mixtures for Shaped Charge Liners
Art Unit: 1742
Confirmation No.: 2977
Examiner: Daniel J. Jenkins
Our File: 1301-1125

Dear Sir:

Enclosed for filing please find the following items (18 + 1 pages) relating to the above-identified application:

- (1) Response to Notice of Non-Compliant Amendment (18 pages).

If you have any questions or comments concerning this matter, please call the undersigned at your earliest convenience. Otherwise, please accept the enclosed.

Sincerely,

Lawrence R. Youst
Reg. No. 38,795
Enclosures

Certificate of Transmission Under 37 C.F.R. §1.8

I hereby certify that this correspondence is being transmitted by facsimile to the United States Patent and Trademark Office on February 18, 2005.

Lawrence R. Youst

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Halliburton Docket No.: 990084 UIC1 USA
Attorney Docket No.: 1301-1125

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application: Leidel et al.

Serial No.: 10/080,785

Filed: February 22, 2002

Art Unit: 1742

Confirmation No.: 2977

Examiner: Daniel J. Jenkins

For: High Performance Powdered Metal Mixtures for
Shaped Charge Liners

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Response to Notice of Non-Compliant Amendment

This is a response to the Notice of Non-Compliant Amendment
dated February 11, 2005 due for reply by March 11, 2005.

Amendments to the Claims are reflected in the listing of
claims which begins on page 2 of this paper.

Remarks begin on page 17 of this paper.